

Qualcomm

Qualcomm[®] QCM4290/

Qualcomm[®] QCS4290 SoCs

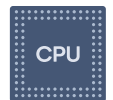
The Qualcomm QCM4290/QCS4290 application processors deliver greater performance, better AI Engine and broader connectivity options compared to previous generations.

The QCM4290/QCS4290 System-on-Chips (SoCs) offer maximum mid-tier benefits delivering greater¹ performance. With the Qualcomm[®] Kryo™ 260 CPU architecture for increased¹ speeds and robust on-device performance, in addition to the 3rd generation Qualcomm[®] AI Engine, this platform delivers powerful performance, dynamic camera capabilities and Wi-Fi 6-ready connectivity, ideal for industrial and commercial IoT applications such as industrial handhelds in logistics and warehousing, security panels and cameras. For increased intuitive on-device intelligence, devices based on this new solution will help enable productive and efficient work environments.

Highlights

Robust performance

The QCM4290/QCS4290 delivers increased¹ speeds and sustained performance powered by the Kryo 260 CPU architecture, so multi-tasking can happen seamlessly with less lag¹. Videos have vivid graphics thanks to the Qualcomm[®] Adreno™ 610 GPU.



Connect confidently

Productivity revolves around strong connections. The QCM4290/QCS4290 is Wi-Fi 6-ready for powerful connections that include battery-saving benefits and enhanced Bluetooth[®] 5.1 capabilities. Wi-Fi 6 also supports WPA-3 security, so you can connect confidently.



Intuitive experiences from on-device AI intelligence

IoT devices should work smarter, not harder. The 3rd gen Qualcomm AI Engine delivers astonishing AI, powering more intuitive on-device AI intelligence. With the Qualcomm[®] Sensing Hub, a device can quickly respond to different needs.



Accelerate time to commercialization

The QCM4290/QCS4290 baseband chipset is pin-to-pin compatible with Qualcomm[®] QCM2290/QCS2290 which helps customers leverage hardware and software development across various IoT devices to reduce cost and time to commercialization.



¹ All comparisons to previous generations

Materials are subject to change without notice.
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Qualcomm QCM4290, Qualcomm QCS4290, Qualcomm QCM2290, Qualcomm QCS2290, Qualcomm Kryo, Qualcomm AI Engine, Qualcomm Adreno and Qualcomm Sensing Hub are products of Qualcomm Technologies, Inc. and/or its subsidiaries.

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QCS4290
QCM4290

QCM4290/QCS4290 Target Applications

- Industrial Handhelds
- Security Panels
- Security Cameras

Features

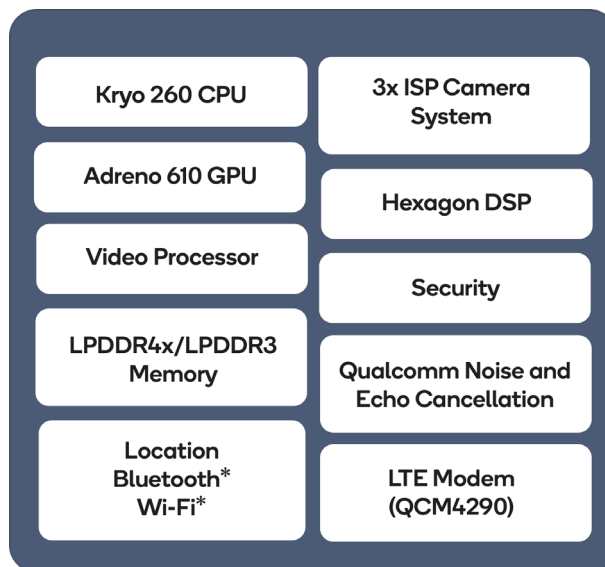
- Kryo 260 CPU, octa-core CPU architecture for increased¹ and sustained speeds
- 11 nm Process Technology for improved performance and lower¹ power consumption
- Dual Frequency GNSS (L1 and L5) and support for India's NavIC satellite system
- Qualcomm® FastConnect™ 6100 system provides the Wi-Fi 6-ready subsystem, integrated with Bluetooth 5.1 and FM.
- Dedicated Qualcomm® Hexagon™ 683 compute DSP with dual Hexagon Vector eXtensions (dual HVX at 1.0 GHz)
- Qualcomm® Universal Bandwidth Compression (UBWC) with display and GPU
- Display support: FHD+, four hardware layers, 10-bit end-to-end, and Qualcomm® True Palette Display feature
- One 4-lane DSI D-PHY 1.2 at 1.5 Gbps per lane, split link supported
- 3x ISP (13 MP + 13 MP)/(25 MP + 5 MP) at 30 fps
- Three 4-lane CSIs (4/4/4 or 4/4/2/1) D-PHY 1.2 at 2.5 Gbps per lane or C-PHY 1.0 at 10 Gbps (3.42 Gbps/trio)
- Support for USB 3.1 Type-C
- Long term support with extended life hardware and software support through 2027

¹All comparisons to previous generations

To learn more visit: www.qualcomm.com

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QCM4290/QCS4290 Block Diagram



* Supported with a companion module

QCM4290/QCS4290 Specifications

Package	752 NSP, 12.0 × 12.4 × 0.91 mm; 04 mm pitch
CPU	8x Kryo 260 CPU from 1.8 up to 2.0 GHz
Modem	6th generation LTE multimode modem 3GPP Rel. 10 with selected 3GPP Rel. 12 features. (QCM4290 only)
Camera Support	13 MP + 13 MP/25 MP + 5 MP at 30 fps or 16 MP + 16 MP at 24 fps
Video	1080p60 8-bit decode for H.264/H.265/VP9, 1080p60 8-bit encode for H.264/H.265
GPU	Adreno 610 GPU @ 950 MHz with support for Open GL ES 3.2, Open CL 2.0, Vulkan 1.1
DSP	Hexagon 683 compute DSP with dual HVX @ 1.0 GHz
Display Support	Adreno 921 DPU
Memory	Dual channel, non-PoP high-speed memory: LPDDR4x SDRAM @ 1866 MHz clock (2 x 16 bit); LPDDR3 SDRAM @ 933 MHz clock (1 x 32 bit)
Audio	Integrated low power island (LPI) for voice UI, Qualcomm® Noise and Echo Cancellation, Qualcomm® Voice Suite
Connectivity	WLAN 1 × 1 802.11a/b/g/n/ac, Bluetooth 5.0, and FM with Qualcomm® WCN3950 or Qualcomm® WCN3988 (1x ax ready)
Location	GPS, GLONASS, NavIC, BeiDou, Galileo, QZSS, and SBAS

Qualcomm FastConnect, Qualcomm Hexagon, Qualcomm Universal Bandwidth Compression, Qualcomm Noise and Echo Cancellation, Qualcomm Voice Suite, Qualcomm WCN3950 and Qualcomm WCN3988 are products of Qualcomm Technologies, Inc. and/or its subsidiaries.

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